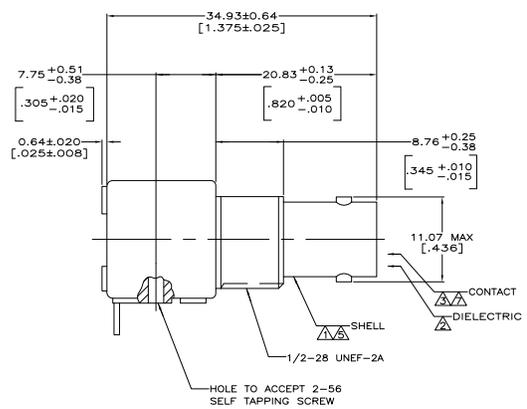
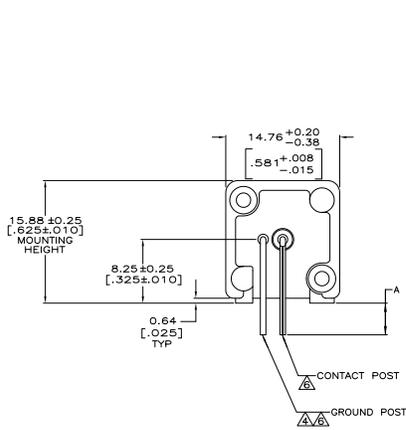
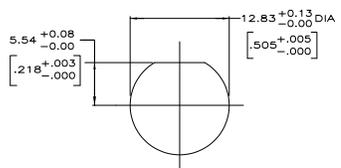


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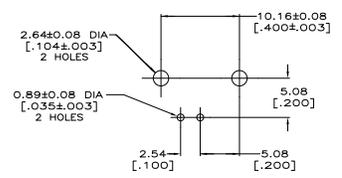
REV	DATE	DESCRIPTION	BY	CHK
AJ	16			
A		REVISED PER EC 0514-0150-05	30MUG95	BM JL
A1		REVISED PER ECO-10-000444	310CT09	KK AEG



- △ ZINC PER QQ-2-363.
- △ POLYMETHYLPENTENE, GENERAL PURPOSE.
- △ PHOSPHOR BRONZE PER QQ-B-750.
- △ BRASS PER ASTM-B-453.
- △ NICKEL PLATE PER QQ-N-290, 3.81µm [.000150] MINIMUM THICK.
- △ TIN PLATE PER ASTM-B-545, 3.81µm [.000150] MINIMUM THICK.
- △ GOLD PLATE PER ASTM-B-488, 0.76µm [.000030] MINIMUM THICK.
- 8. SEE INSTRUCTION SHEET 408-2769.
- △ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



RECOMMENDED PANEL CUTOUT



PCB CONFIGURATION

△ OBSOLETE	2.79 ± 0.25 [1.10 ± 0.10]	4.227676-2
	4.11 ± 0.43 [1.62 ± 0.17]	5227676-1
A		PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DATE	BY	CHKD	APP'D
DATE	BY	CHKD	APP'D	Tti Electronics Corporation Harrisburg, Pa 17105-3608	
DESCRIPTION	QUANTITY	DATE	BY	CHKD	APP'D
108-12078					
CUSTOMER DRAWING		DATE	BY	CHKD	APP'D
A1		00779	5227676		